

**ON Semiconductor®** 

# FDS6898AZ-F085

## Dual N-Channel Logic Level PWM Optimized PowerTrench® MOSFET

### **General Description**

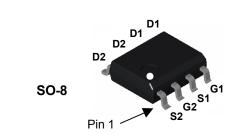
These N-Channel Logic Level MOSFETs are produced using ON Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

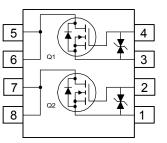
These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.



### Features

- 9.4 A, 20 V  $R_{DS(ON)}$  = 14 m $\Omega$  @ V<sub>GS</sub> = 4.5 V
  - $R_{DS(ON)}$  = 18 m $\Omega$  @ V<sub>GS</sub> = 2.5 V
- Low gate charge (16 nC typical)
- ESD protection diode (note 3)
- High performance trench technology for extremely low R<sub>DS(ON)</sub>
- High power and current handling capability
- Qualified to AEC Q101
- RoHS Compliant





#### Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		20	V
V <sub>GSS</sub>	Gate-Source Voltage		± 12	V
I <sub>D</sub>	Drain Current – Continuous	(Note 1a)	9.4	А
	- Pulsed		38	
P <sub>D</sub>	Power Dissipation for Dual Operation		2	W
	Power Dissipation for Single Operation	(Note 1a)	1.6	
		(Note 1b)	1	
		(Note 1c)	0.9	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperatu	re Range	–55 to +150	°C
Therma	I Characteristics			
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	40	°C/W

Thermal Resistance, Junction-to-Case 40  $R_{\theta JC}$ (Note 1)

## Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
FDS6898AZ	FDS6898AZ-F085	13"	12mm	2500 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	racteristics					
BV <sub>DSS</sub>	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$ , $I_D = 250 \mu A$	20			V
<u>ΔBV<sub>DSS</sub></u> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 µA, Referenced to 25°C		21		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 16 V$ , $V_{GS} = 0 V$			1	μA
I <sub>GSSF</sub>	Gate–Body Leakage, Forward	$V_{GS}$ = 12 V, $V_{DS}$ = 0 V			10	μA
I <sub>GSSR</sub>	Gate-Body Leakage, Reverse	$V_{GS} = -12 V$ , $V_{DS} = 0 V$			-10	μA
On Char	racteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, \qquad I_D = 250 \ \mu A$	0.5	1	1.5	V
<u>ΔV<sub>GS(th)</sub></u> ΔT <sub>J</sub>	Gate Threshold Voltage Temperature Coefficient	$I_D$ = 250 µA, Referenced to 25°C		-3.5		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{\rm GS} = 4.5 \ V, \ I_{\rm D} = 9.4 \ A \\ V_{\rm GS} = 2.5 \ V, \ I_{\rm D} = 8.3 \ A \\ V_{\rm GS} = 4.5 \ V, \ I_{\rm D} = 9.4 \ A, T_{\rm J} = 125^{\circ} C \end{array} $		10 13 14	14 18 21	mΩ
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = 4.5V, V_{DS} = 5V$	19			А
<b>g</b> <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 V$ , $I_{D} = 9.4 A$		47		S
Dvnami	c Characteristics				•	•
Ciss	Input Capacitance	$V_{DS} = 10 V$ , $V_{GS} = 0 V$ ,		1821		pF
Coss	Output Capacitance	f = 1.0 MHz		440		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			208		pF
Switchir	ng Characteristics (Note 2)	1				
t <sub>d(on)</sub>	Turn–On Delay Time	$V_{DD} = 10 V$ , $I_D = 1 A$ ,		10	20	ns
t <sub>r</sub>	Turn–On Rise Time	$V_{GS} = 4.5 V$ , $R_{GEN} = 6 \Omega$		15	27	ns
t <sub>d(off)</sub>	Turn–Off Delay Time			34	55	ns
t <sub>f</sub>	Turn–Off Fall Time			16	29	ns
Qg	Total Gate Charge	$V_{DS} = 10 V$ , $I_D = 9.4 A$ ,		16	23	nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> = 4.5 V		3	Ì	nC
Q <sub>gd</sub>	Gate–Drain Charge			4		nC
	ource Diode Characteristics	and Maximum Ratings				
	Maximum Continuous Drain–Source	•			1.3	А
l <sub>s</sub>		$V_{GS} = 0 V$ , $I_S = 1.3 A$ (Note 2)		0.7	1.2	V

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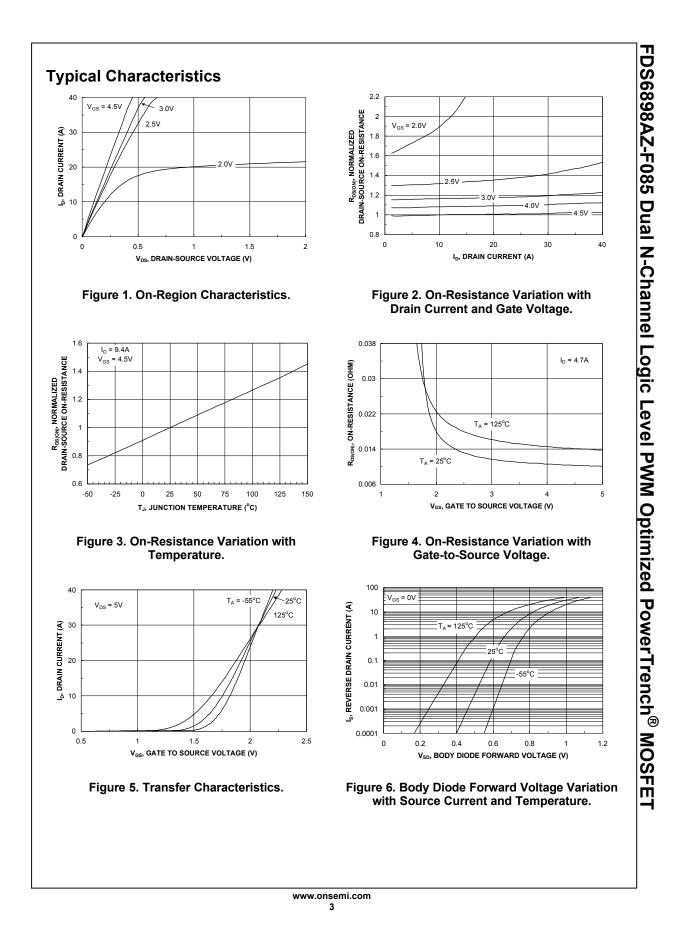
Scale 1 : 1 on letter size paper

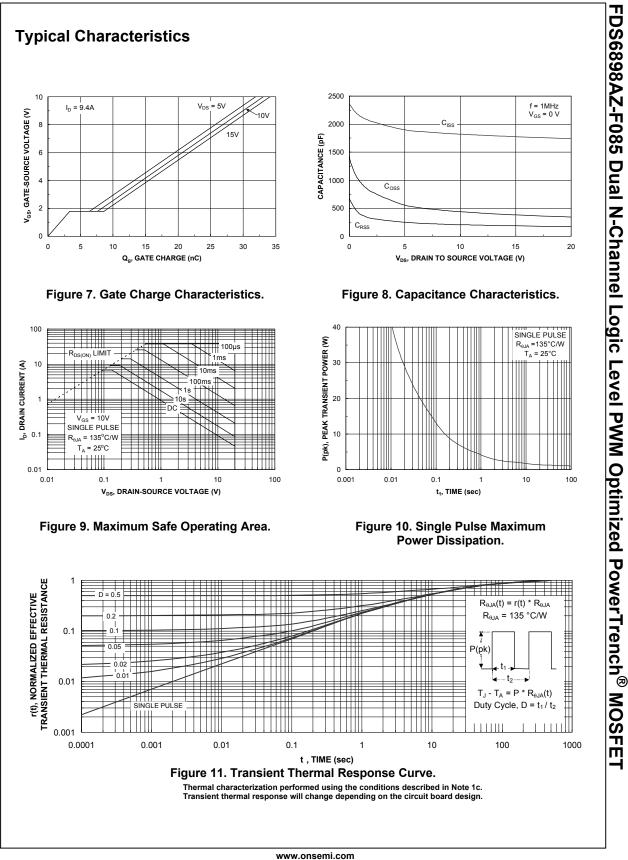
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2. Pulse Test: Pulse Width < 300 $\mu$ s, Duty Cycle < 2.0%

3. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied

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